

APPLICABLE STANDARD				
RATING	VOLTAGE	150 V AC	CURRENT	1 A
	OPERATING TEMPERATURE RANGE	-35°C TO +85 °C (NOTES 1)	STORAGE TEMPERATURE RANGE	-10°C TO +60°C (NOTE3)
	OPERATING HUMIDITY RANGE	20 % TO 80 % (NOTES 2)	STORAGE HUMIDITY RANGE	20 % TO 70 % (NOTE3)
	APPLICABLE CONNECTOR	DF13-*S-1.25C	APPLICABLE CONTACT	DF13-2630SCFA, DF13-3032SCFA

### SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
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#### CONSTRUCTION

GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X

#### ELECTRIC CHARACTERISTICS

CONTACT RESISTANCE	100 m A (DC OR 1000 Hz).	30 mΩ MAX.	X	-
INSULATION RESISTANCE	100 V DC.	500 MΩ MIN.	X	-
VOLTAGE PROOF	500 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	-

#### MECHANICAL CHARACTERISTICS

MECHANICAL OPERATION	50 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
SHOCK	490 m/s <sup>2</sup> DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	-

#### ENVIRONMENTAL CHARACTERISTICS

RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55 → 5 TO 35 → +85 → 5 TO 35 °C TIME 30 → 5 MAX → 30 → 5 MAX min. UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		X	-
SALT MIST	EXPOSED IN 5 % SALT WATER SPRAY 48 h.	① CONTACT RESISTANCE: 30mΩ MAX. ② NO DEFECT SUCH AS CORROSION WHICH IMPAIRS THE FUNCTION OF CONNECTOR.	X	-
SULFUR DIOXIDE GAS	EXPOSED IN 10 PPM 96h.		X	-
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING «REFLOW AREA» MAX250°C WITHIN 10 sec MIN 230°C WITHIN 60 sec «PREHEATING AREA» 170°C to 190°C 60 sec to 120 sec PUT THROUGH IN REFLOW FURNACE TWICE, LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :250 ± 10°C, SOLDERING TIME : 5sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	-
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230 ± 5°C FOR INSERTION DURATION, 3sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.	X	-

#### REMARKS

NOTE1: INCLUDE THE TEMPERATURE RISING BY CURRENT.

NOTE2:NO CONDENSING.

NOTE3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFOR PCB ON BOARD.

AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STRAGE DURING TRANSPORTATION.

COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
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Unless otherwise specified, refer to JIS C5402.			APPROVED	TY.OMA 06.05.11
			CHECKED	HK.UMEHARA 06.05.11
			DESIGNED	TS.KUMAZAWA 06.05.09
			DRAWN	AK.MIURA 06.04.28

Note	QT:Qualification Test AT:Assurance Test X:Applicable Test	DRAWING NO.	ELC4-083664-02	
	SPECIFICATION SHEET	PART NO.	DF13-*P-1.25V (50)	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL536	△ 1/1